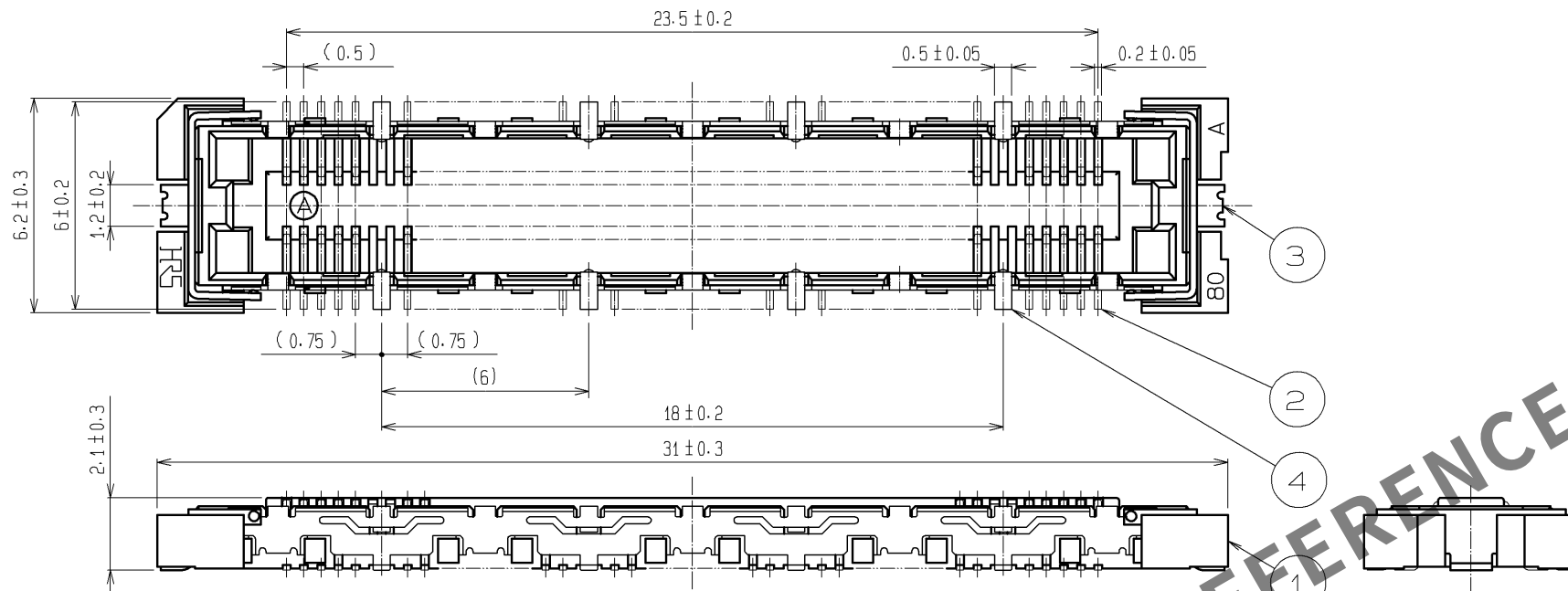
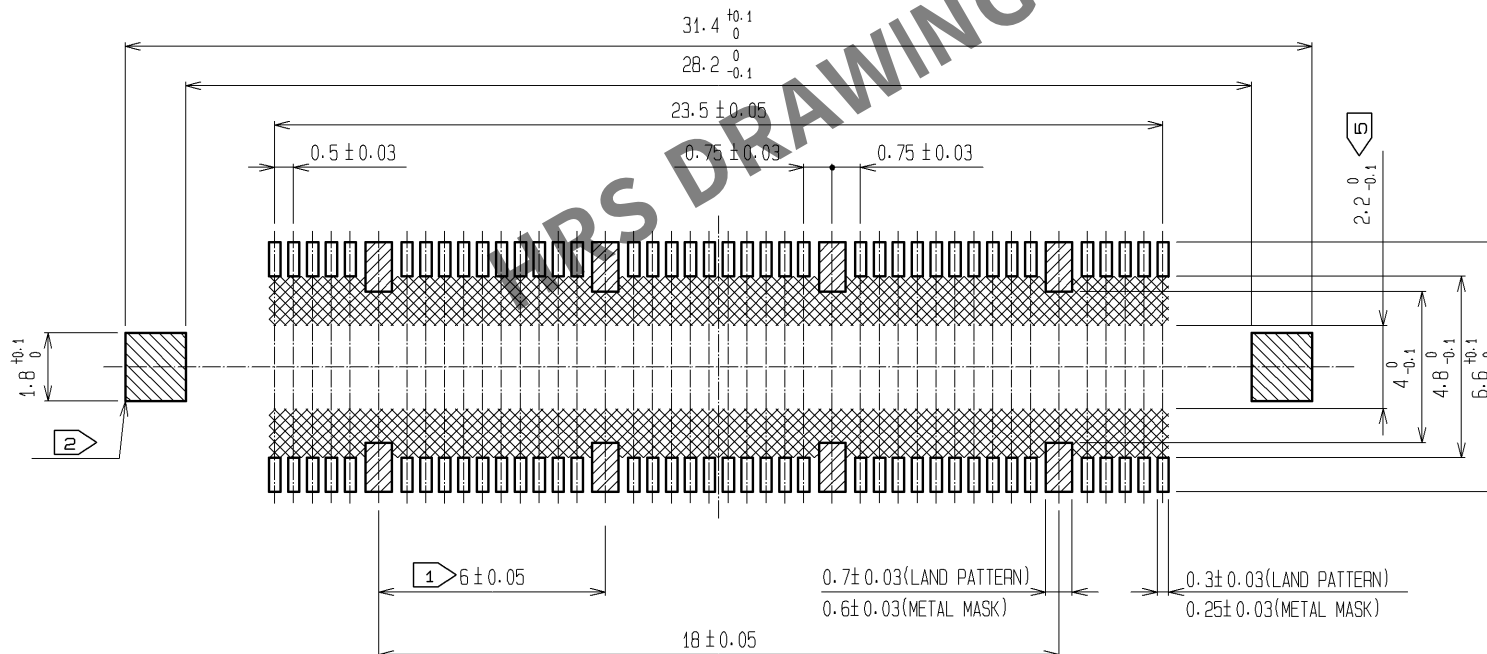
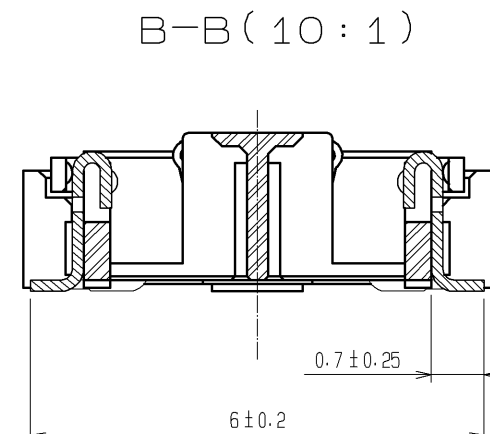
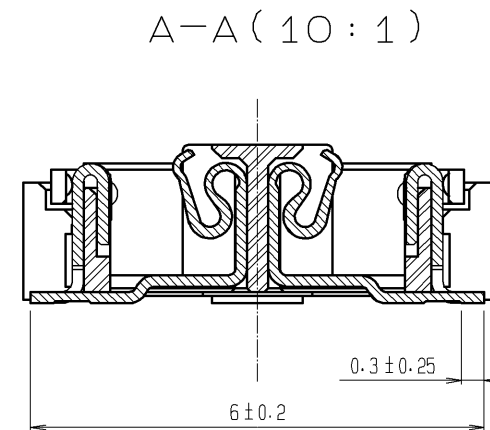




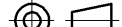
RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS:0.15mm)



- NOTES
- ④ 8 HATCHED  PARTS:GROUND CIRUIT.
 - ② 2 HATCHED  PARTS:GROUND CIRUIT.
 - ③ SMT LEAD-COPLANARITY:0.1 MAX.
 - ④ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - ⑤ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND ,OR LEAD MAY TOUCH PATTERN.(THIS APPLIES TO HATCHED  AREA.)
 - ⑥ THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.



3. 4	PHOSPHOR BRONZE	TIN PLATING
2	PHOSPHOR BRONZE	CONTACT AREA : GOLD 0.1µm min.
		LEAD AREA : GOLD 0.05µm min.
		UNDER PLATING : NICKEL 1µm min.
NO.	MATERIAL	FINISH , REMARKS

1	LCP	BEIGE UL94V-0					UNDER PLATING : NICKEL 1μm min.			
NO.	MATERIAL	FINISH , REMARKS		NO.	MATERIAL	FINISH , REMARKS				
UNITS mm			SCALE 5 : 1		COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA		09. 10. 19		DRAWING NO.		EDC3-152637-25		
		CHECED : HT. YAMAGUCHI		09. 10. 19		PART NO.		FX11B-80S/8-SV(71)		
		DESIGNED : SY. KAMIGA		09. 10. 17		CODE NO.		CL573-0713-5-71		
		DRAWN : HK. SUNADORI		09. 10. 17				 1		